

Abstract Submitted  
for the MAR13 Meeting of  
The American Physical Society

**The origin of the high hole density in  $\text{In}_x\text{Ga}_{1-x}\text{N:Mg}$ <sup>1</sup>** WILLIAM WILLOUGHBY, MARY ELLEN ZVANUT, University of Alabama at Birmingham — InGaN is the nitride of choice for applications requiring high hole density and emission tunability. The increased hole density with In incorporation may be explained by several different mechanisms; however, our electron paramagnetic resonance (EPR) studies reveal a surprising feature: the number of Mg-related acceptors decreases with increasing hole density.  $\text{In}_x\text{Ga}_{1-x}\text{N}$  films, with  $x$  between 0.02 and 0.11 and thickness between 0.25 and 0.44  $\mu\text{m}$ , were grown p-type by doping with Mg to a concentration of  $2\text{-}3 \times 10^{19} \text{ cm}^{-3}$ . Hall measurements reveal the expected hole density increase from  $5\text{-}30 \times 10^{17} \text{ cm}^{-3}$  with increasing In mole fraction. However, unlike GaN:Mg where the EPR Mg signal tracks the hole density, the EPR intensity of the Mg-related signal in InGaN is found to decrease as the hole density increases. Together, compensating defects and a lowering of the acceptor level may explain the decrease in EPR intensity and the increase in hole density observed as the In mole fraction is increased.

<sup>1</sup>Dr. D. Koleske grew the samples and performed the Hall measurements. The work is supported by the National Science Foundation, DMR-1006163.

Mary Ellen Zvanut  
University of Alabama at Birmingham

Date submitted: 19 Nov 2012

Electronic form version 1.4